

September 2000 Revised September 2000

74LCXH16244 Low Voltage 16-Bit Buffer/Line Driver with Bushold

General Description

The LCXH16244 contains sixteen non-inverting buffers with 3-STATE outputs designed to be employed as a memory and address driver, clock driver, or bus oriented transmitter/receiver. The device is nibble controlled. Each nibble has separate 3-STATE control inputs which can be shorted together for full 16-bit operation.

The LCXH16244 data inputs include active bushold circuitry, eliminating the need for external pull-up resistors to hold unused or floating data inputs at a valid logic level.

The LCXH16244 is designed for low voltage (2.5V or 3.3V) V_{CC} applications with capability of interfacing to a 5V signal environment.

The LCXH16244 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

Features

- 5V tolerant control inputs and outputs
- 2.3V-3.6V V_{CC} specifications provided
- \blacksquare 4.5 ns t_{PD} max (V_{CC} = 3.0V), 20 μ A I_{CC} max
- Bushold on inputs eliminates the need for external pull-up/pull-down resistors
- Power down high impedance inputs and outputs
- \blacksquare ±24 mA output drive (V_{CC} = 3.0V)
- Implements patented noise/EMI reduction circuitry
- Latch-up performance exceeds 500 mA
- ESD performance:

Human body model > 2000V Machine model > 200V

Ordering Code:

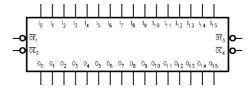
Order Number	Package Number	Package Description
74LCXH16244MEA	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300 Wide
74LCXH16244MTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Logic Symbol



Pin Descriptions

Pin Names	Description
ŌE _n	Output Enable Input (Active LOW)
I ₀ -I ₁₅	Bushold Inputs
O ₀ -O ₁₅	Outputs

Truth Tables

Inp	uts	Outputs
OE ₁	I ₀ –I ₃	O ₀ -O ₃
L	L	L
L	Н	н
Н	×	Z

Inp	uts	Outputs
OE ₃	I ₈ −I ₁₁	O ₈ -O ₁₁
L	L	L
L	Н	Н
н	X	Z

Inp	Inputs		
OE ₂	I ₄ –I ₇	O ₄ -O ₇	
L	L	L	
L	Н	Н	
Н	X	Z	

Inp	uts	Outputs
OE ₄	I ₁₂ -I ₁₅	O ₁₂ -O ₁₅
L	L	L
L	Н	Н
Н	X	Z

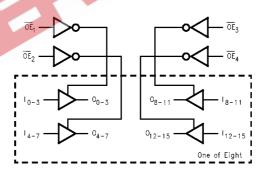
H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial Z = High Impedance

Functional Description

The LCXH16244 contains sixteen non-inverting buffers with 3-STATE standard outputs. The device is nibble (4 bits) controlled with each nibble functioning identically, but independent of the other. The control pins can be shorted together to obtain full 16-bit operation. The

3-STATE outputs are controlled by an Output Enable (\overline{OE}_n) input for each nibble. When \overline{OE}_n is LOW, the outputs are in 2-state mode. When \overline{OE}_n is HIGH, the outputs are in the high impedance mode, but this does not interfere with entering new data into the inputs.

Logic Diagram



Abso	lute Maximum F	Ratings	ote 1)			
Symbol	Paramete	r	Value	Conditions	Units	
V _{CC}	Supply Voltage		-0.5 to +7.0		V	
V _I	DC Input Voltage OE		-0.5 to +7.0		V	
		I ₀ - I ₁₅	-0.5 to V _{CC} + 0.5	1	V	
Vo	DC Output Voltage	•	−0.5 to +7.0	Output in 3-STATE	V	
			-0.5 to $V_{CC} + 0.5$	Output in HIGH or LOW State (Note 2)	V	
I _{IK}	DC Input Diode Current		-50	V _I < GND	mA	
I _{OK}	DC Output Diode Currer	nt	-50	V _O < GND	A	
			+50	V _O > V _{CC}	mA	
Io	DC Output Source/Sink	Current	±50		mA	
I _{CC}	DC Supply Current per Supply Pin		±100		mA	
I _{GND}	DC Ground Current per Ground Pin		±100		mA	
T _{STG}	Storage Temperature		-65 to +150		°C	

Recommended Operating Conditions (Note 3)

Symbol	Parameter		Min	Max	Units
V _{CC}	Supply Voltage	Operating	2.0	3.6	.,
		Data Retention	1.5	3.6	V
VI	Input Voltage	20 1	0	V _{CC}	V
Vo	Output Voltage	HIGH or LOW State	0	V_{CC}	V
		3-STATE	0	5.5	V
I _{OH} /I _{OL}	Output Current	$V_{CC} = 3.0V - 3.6V$		±24	
		$V_{CC} = 2.7V - 3.0V$		±12	mA
		$V_{CC} = 2.3V - 2.7V$		±8	
T _A	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, V _{IN} = 0.8V-2.0V, V _{CC} = 3.0V		0	10	ns/V

Note 1: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: I_O Absolute Maximum Rating must be observed.

Note 3: Floating or unused control inputs must be held HIGH or LOW.

DC Electrical Characteristics

Symbol	Parameter		Conditions	V _{CC}	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units
Cymbol				(V)	Min	Max	Ullits
V _{IH}	HIGH Level Input Voltage			2.3 – 2.7	1.7		V
				2.7 – 3.6	2.0		V
V _{IL}	LOW Level Input Voltage			2.3 – 2.7		0.7	V
				2.7 – 3.6		0.8	V
V _{OH}	HIGH Level Output Voltage		$I_{OH} = -100 \mu A$	2.3 – 3.6	V _{CC} - 0.2		
			$I_{OH} = -8 \text{ mA}$	2.3	1.8		
			$I_{OH} = -12 \text{ mA}$	2.7	2.2		V
			$I_{OH} = -18 \text{ mA}$	3.0	2.4		
			$I_{OH} = -24 \text{ mA}$	3.0	2.2		
V _{OL}	LOW Level Output Voltage		$I_{OL} = 100 \mu A$	2.3 – 3.6		0.2	
			I _{OL} = 8 mA	2.3		0.6	
			I _{OL} = 12 mA	2.7		0.4	V
			I _{OL} = 16 mA	3.0		0.4	
			I _{OL} = 24 mA	3.0		0.55	
l _l	Input Leakage Current	Data	$V_I = V_{CC}$ or GND	2.3 – 3.6		±5.0	μА
		Control	0 ≤ V ₁ ≤ 5.5	2.3 - 3.6		±5.0	μΛ

DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	v _{cc}	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units
Oyboi		Conditions	(V)	Min	Max	Onits
I _{I(HOLD)}	Bushold Input Minimum	$V_{IN} = 0.7V$	2.3	45		
	Drive Hold Current	V _{IN} = 1.7V	2.5	-45		μА
		$V_{IN} = 0.8V$	3.0	75		μΑ
		$V_{IN} = 2.0V$	3.0	-75		
I _{I(OD)}	Bushold Input Over-Drive	(Note 4)	2.7	300		
	Current to Change State	(Note 5)	2.1	-300		μА
		(Note 4)	3.6	450		μΑ
		(Note 5)	3.0	-450		
l _{oz}	3-STATE Output Leakage	$0 \le V_O \le 5.5V$	2.3 – 3.6		±5.0	μА
		$V_I = V_{IH}$ or V_{IL}	2.3 – 3.6		±3.0	μΑ
I _{OFF}	Power-Off Leakage Current	V _O = 5.5V	0		10	μΑ
I _{CC}	Quiescent Supply Current	$V_I = V_{CC}$ or GND	2.3 – 3.6		20	μΑ
Δl _{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6V$	2.3 - 3.6		500	μΑ

Note 4: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 5: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

AC Electrical Characteristics

		$T_{A} = -40^{\circ}\text{C to } +85^{\circ}\text{C}, R_{L} = 500 \Omega$						
Symbol	Parameter	V _{CC} = 3.	3V ± 0.3V	V _{CC}	= 2.7V	V _{CC} = 2.	5V ± 0.2V	Units
Зупівої	r al afficiel	C _L =	50 pF	C _L =	50 pF	C _L =	30 pF	Onits
		Min	Max	Min	Max	Min	Max	
t _{PHL}	Propagation Delay	1.0	4.5	1.0	5.2	1.0	5.4	
t _{PLH}	Data to Output	1.0	4.5	1.0	5.2	1.0	5.4	ns
t _{PZL}	Output Enable Time	1.0	5.5	1.0	6.3	1.0	7.2	no
t _{PZH}		1.0	5.5	1.0	6.3	1.0	7.2	ns
t _{PLZ}	Output Disable Time	1.0	5.4	1.0	5.7	1.0	6.5	
t_{PHZ}		1.0	5.4	1.0	5.7	1.0	6.5	ns
t _{OSHL}	Output to Output Skew (Note 6)		1.0					ns
t _{OSLH}			1.0					113

Note 6: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}). Parameter guaranteed by design.

Dynamic Switching Characteristics V_{CC} $T_A = 25^{\circ}C$ Symbol Parameter Conditions (V) Typical Quiet Output Dynamic Peak VOL $C_L = 50 \text{ pF}, V_{IH} = 3.3V, V_{IL} = 0V$ 3.3 C_L = 30 pF, V_{IH} = 2.5V, V_{IL} = 0V C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V 0.6 Quiet Output Dynamic Valley V_{OL} -0.8 ٧ $C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$ -0.6

Capacitance

Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	V_{CC} = Open, V_I = 0V or V_{CC}	7	pF
C _{OUT}	Output Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	$V_{CC} = 3.3V$, $V_{I} = 0V$ or V_{CC} , $f = 10$ MHz	20	pF



AC LOADING and WAVEFORMS Generic for LCX Family

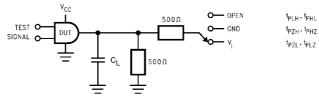
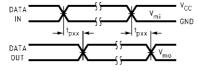
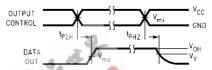


FIGURE 1. AC Test Circuit (C_L includes probe and jig capacitance)

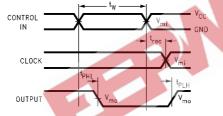
V _I	CL
6V for V _{CC} = 3.3V, 2.7V	50 pF
V_{CC} * 2 for V_{CC} = 2.5V	30 pF



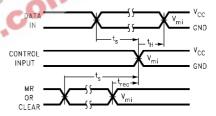
Waveform for Inverting and Non-Inverting Functions



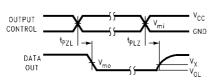
3-STATE Output High Enable and Disable Times for Logic



Propagation Delay. Pulse Width and $t_{\rm rec}$ Waveforms



Setup Time, Hold Time and Recovery Time for Logic



3-STATE Output Low Enable and Disable Times for Logic

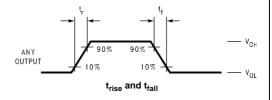
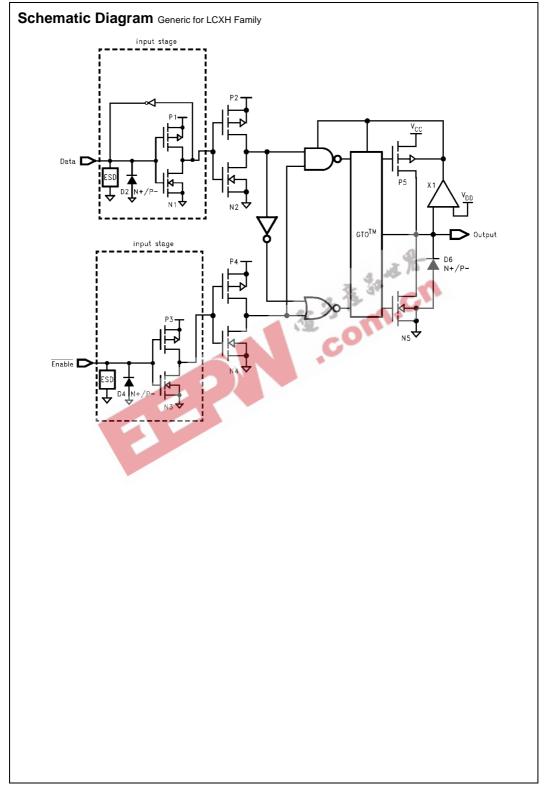
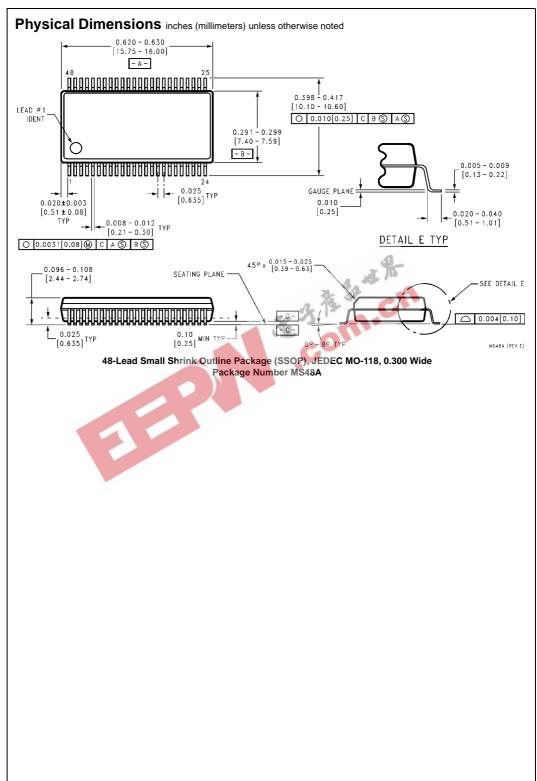
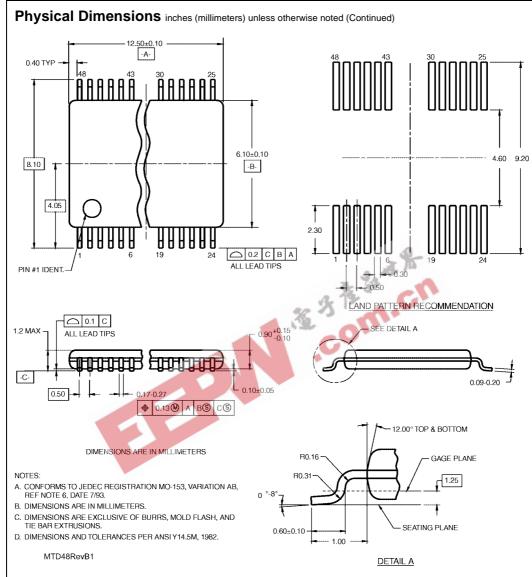


FIGURE 2. Waveforms (Input Characteristics; f = 1 MHz, $t_R = t_F = 3 \text{ns}$)

Symbol	V _{cc}		
	$3.3V \pm 0.3V$	2.7V	2.5V ± 0.2V
V _{mi}	1.5V	1.5V	V _{CC} /2
V_{mo}	1.5V	1.5V	V _{CC} /2
V _x	V _{OL} + 0.3V	V _{OL} + 0.3V	V _{OL} + 0.15V
V _y	V _{OH} – 0.3V	V _{OH} – 0.3V	V _{OH} – 0.15V







48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD48

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